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APPLICATION FOR U.S. PATENT TRANSMITTAL FORM

September 24, 2003

Express Mail label number under 37 C.F.R. § 1.10:
EU 640981682US

Mail Stop PATENT APPLICATION
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

EU 640981682 US

Dear Sir:

Transmitted herewith for filing is the patent application of:

Inventors: Burke et al

For: High Capacitive Density Stacked Decoupling Capacitor Structure

Enclosed are a patent application including 23 pages of specification, 2 sheets of Formal drawings, an executed Declaration and Power of Attorney, a Preliminary Amendment, an Information Disclosure Statement (with Form PTO/SB/08A) as well as an Assignment (with cover sheet) of the invention to TEXAS INSTRUMENTS INCORPORATED, P.O. Box 655474, MS3999, Dallas, Texas 75265.

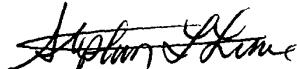
FEE CALCULATION				FEE
		Number	Basic Fee	750
			Extra Rate	
Total Claims	34	20	14	18 252
Independent Claims	3	3	0	84 0
			TOTAL FEES	1002

Please charge deposit account No. 20-0668 in the amount of the Total Fees set forth above. The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to said deposit account. **A duplicate copy of this sheet is enclosed.**

All correspondence regarding this application may be directed to Applicants' attorney at **Customer number 23494**, or at the below listed telephone number and address.

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Respectfully submitted,



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